



P-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	RDS(ON) Max	I _{D Max} T _A = +25°C
-20V	$30m\Omega$ @ $V_{GS} = -4.5V$	-6.0A
-20V	$39m\Omega$ @ $V_{GS} = -2.5V$	-5.5A

Features and Benefits

- Low Input Capacitance
- Low On-Resistance
- Fast Switching Speed
- **ESD Protected**
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Description and Applications

This MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) and yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

- **DC-DC Converters**
- Motor Control
- **Power Management Functions**
- Analog Switch

Mechanical Data

- Case: TSOT26
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe; Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.013 grams (Approximate)

6 D

5 D

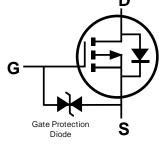
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Top View





Top View Pin-Out

Equivalent Circuit

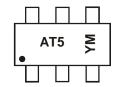
Ordering Information (Note 4)

Part Number	Case	Packaging
DMP2036UVT-7	TSOT26	3,000/Tape & Reel
DMP2036UVT-13	TSOT26	10,000/Tape & Reel

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. Notes:

- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

Marking Information



AT5 = Product Type Marking Code YM = Date Code Marking Y or \overline{Y} = Year (ex: F = 2018) M = Month (ex: 9 = September)

Date Code Key

Year	2017	2018	20	019	2020	2021	l	2022	2023	20	24	2025
Code	E	F		G	Н	- 1		J	K	L	_	М
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

DMP2036UVT Document number: DS40059 Rev. 2 - 2 1 of 7



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage			V_{DSS}	-20	V
Gate-Source Voltage	V_{GSS}	±8	V		
Continuous Drain Current (Note 6) V _{GS} = -4.5V	I _D	-6.0 -5.0	А		
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I _{DM}	-40	Α		
Continuous Source-Drain Diode Current (Note 6)	Is	-2,2	Α		
Avalanche Current (Note 7) L = 0.1mH	I _{AS}	-21	Α		
Avalanche Energy (Note 7) L = 0.1mH	E _{AS}	23	mJ		

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Total Dawer Discinction (Note 5)	$T_A = +25^{\circ}C$	Б	1.1	W	
Total Power Dissipation (Note 5)	$T_A = +70^{\circ}C$	P_{D}	0.7	VV	
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	R _{0JA}	108	°C/W	
Total Dayor Dissination (Note 6)	T _A = +25°C	D.	1.5	W	
Total Power Dissipation (Note 6)	$T_A = +70^{\circ}C$	P_{D}	1.0	VV	
Thermal Resistance, Junction to Ambient (Note 6) Steady State		R _{0JA}	81	°C/W	
Thermal Resistance, Junction to Case (Note 6)	Steady State	R ₀ JC	16	C/VV	
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to +150	°C	

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition		
OFF CHARACTERISTICS (Note 8)								
Drain-Source Breakdown Voltage	BV _{DSS}	-20	_	_	V	$V_{GS} = 0V, I_{D} = -250\mu A$		
Zero Gate Voltage Drain Current T _J = +25°C	I _{DSS}	_	_	-1	μΑ	$V_{DS} = -16V, V_{GS} = 0V$		
Gate-Source Leakage	I _{GSS}	_	_	±10	μΑ	$V_{GS} = \pm 8V$, $V_{DS} = 0V$		
ON CHARACTERISTICS (Note 8)								
Gate Threshold Voltage	$V_{GS(TH)}$	-0.4	_	-1.0	٧	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$		
			24	30		$V_{GS} = -4.5V, I_{D} = -6.4A$		
Static Drain-Source On-Resistance	R _{DS(ON)}	_	31	39	mΩ	$V_{GS} = -2.5V, I_D = -4.8A$		
	, ,		41	58		$V_{GS} = -1.8V, I_D = -2.5A$		
Diode Forward Voltage	V _{SD}	_	-0.7	-1.2	V	V _G S = 0V, I _S = -1.0A		
DYNAMIC CHARACTERISTICS (Note 9)								
Input Capacitance	C _{iss}	_	1,808	_		15)()(
Output Capacitance	Coss	_	155	_	pF	$V_{DS} = -15V, V_{GS} = 0V,$ f = 1.0MHz		
Reverse Transfer Capacitance	C _{rss}	_	117	_		I = I.OWIHZ		
Gate Resistance	Rg	_	32	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$		
Total Gate Charge (V _{GS} = -4.5V)	Qq	_	20.5	_				
Gate-Source Charge	Q _{gs}	_	2.8	_	nC	$V_{DS} = -10V, V_{GS} = -4.5V,$		
Gate-Drain Charge	Q _{gd}	_	4.1	_		$I_D = -4.0A$		
Turn-On Delay Time	t _{D(ON)}	_	9.1	_				
Turn-On Rise Time	t _R	_	12.3	_		$V_{DS} = -10V, V_{GS} = -4.5V,$		
Turn-Off Delay Time	t _{D(OFF)}	_	120	_	ns	$R_g = 6\Omega, I_D = -1.0A$		
Turn-Off Fall Time	t _F	_	54	_				
Reverse Recovery Time	t _{RR}	_	23.1	_	ns	I _F = -1.0A, di/dt = 100A/μs		
Reverse Recovery Charge	Q _{RR}	_	8.3	_	nC	I _F = -1.0A, di/dt = 100A/μs		

Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

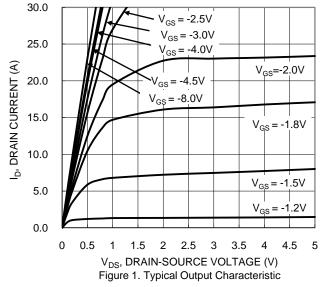
^{6.} Device mounted on FR-4 substrate PC board, 2oz copper, with 1-inch square copper plate.

^{7.} I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep $T_J = +25^{\circ}C$.

^{8.} Short duration pulse test used to minimize self-heating effect.

^{9.} Guaranteed by design. Not subject to product testing.





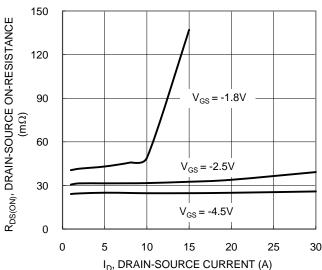


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

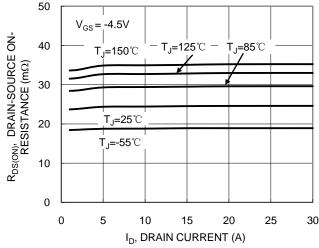
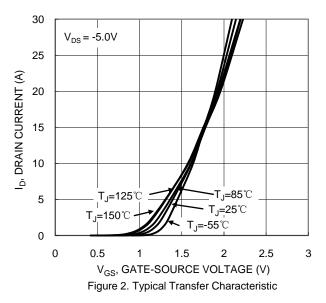


Figure 5. Typical On-Resistance vs. Drain Current and Temperature



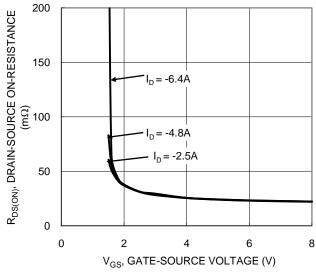


Figure 4. Typical Transfer Characteristic

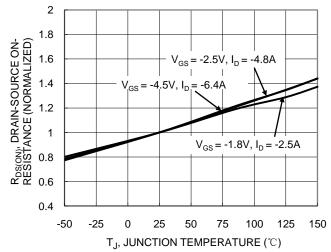


Figure 6. On-Resistance Variation with Temperature



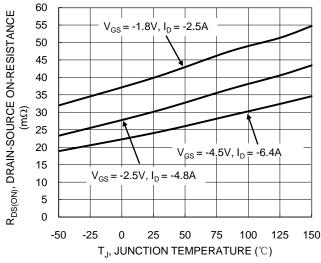


Figure 7. On-Resistance Variation with Temperature

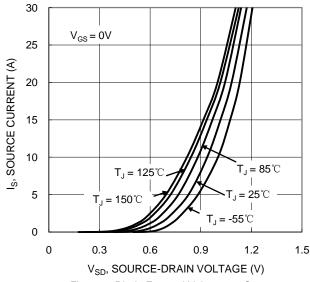
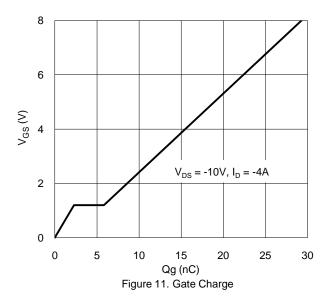


Figure 9. Diode Forward Voltage vs. Current



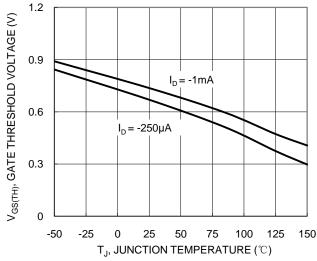


Figure 8. Gate Threshold Variation vs. Junction Temperature

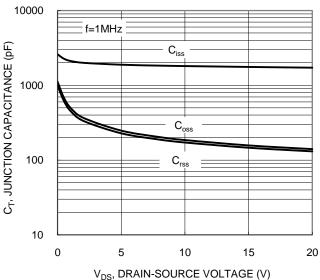
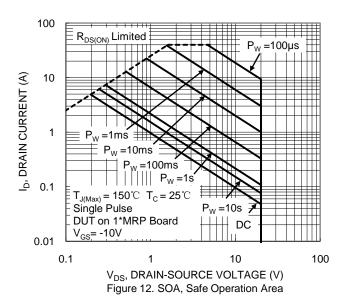


Figure 10. Typical Junction Capacitance





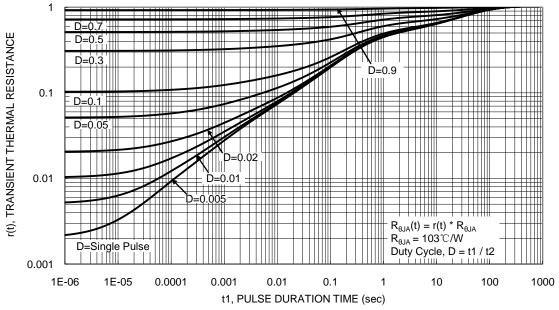
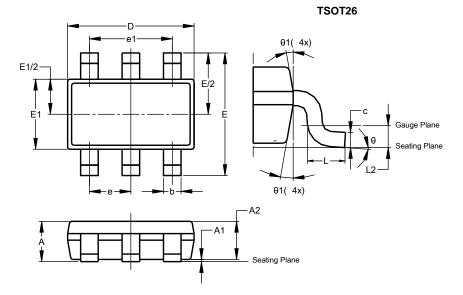


Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

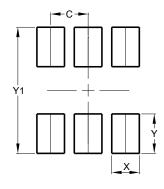


TSOT26							
Dim	Min	Max	Тур				
Α	-	1.00	-				
A1	0.010	0.100	-				
A2	0.840	0.900	-				
D	2.800	3.000	2.900				
Е	2	.800 BS	С				
E1	1.500	1.700	1.600				
b	0.300	0.450	_				
С	0.120	0.200	1				
е	0.950 BSC						
e1	1	1.900 BSC					
L	0.30 0.50 -						
L2	0.250 BSC						
θ	0°	0° 8° 4°					
θ1	4°	12°	-				
All Dimensions in mm							

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

TSOT26



Dimensions	Value (in mm)
С	0.950
Х	0.700
Y	1.000
Y1	3 100



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